

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10511102
<b>Filing Date:</b>	14-Oct-2004
<b>Title of Invention:</b>	Thermosetting resin composition and prepreg and laminated sheet using the same
<b>First Named Inventor:</b>	Shinji Tsuchikawa
<b>Filer:</b>	Joerg-Uwe V. Szipl/Nichole Vasquez
<b>Attorney Docket Number:</b>	TSUK0010

Filed as Large Entity

### **U.S. National Stage under 35 USC 371 Filing Fees**

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
<b>Post-Allowance-and-Post-Issurance:</b>				
<b>Extension-of-Time:</b>				
Extension for response within 3rd month	1253	1	1020	1020

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Miscellaneous:</b>				
Submission- Information Disclosure Stmt	1806	1	180	180
<b>Total in USD (\$)</b>				<b>1200</b>